

IMPORTANT: APPLICATION DEADLINE EXTENDED!

Application Closing Date: ~~24 June 2024~~ **31 October 2024**



HUAWEI TECHNOLOGIES (MALAYSIA) SDN BHD SCHOLARSHIP

Scholarship Amount (Per Annum)

- | Scholarship Amount (Per Annum) | |
|--------------------------------|-----------|
| • All Degree Programmes | RM 10,000 |

Eligibility Criteria

- Eligible for Year 2 – 4 degree student only.
- Eligible for Malaysia citizen only.
- CGPA requirement: Minimum 3.2000.
- Priority for student with Huawei certificate HCIA/HCIP/HCIE.
- Priority for student who selected for Huawei Seeds program and training program.
- Sponsored Student is required to work for Huawei for a minimum period of 2 years from the service commencement date, failing which the Sponsored Student is liable to reimburse the Sponsor the entire amount of the Sponsored Fees.

How to Apply

Obtain the Application Form from

- Department of Scholarships and Financial Aid Website:
<https://dsfa.utar.edu.my/Huawei-Technologies-Sdn-Bhd-Scholarship.php>

Inquiry

Person to Contact	: Department of Scholarships and Financial Aid (DSFA)
Telephone	: 05-4688888 Ext: 2574 (Kampar Campus) / 03-90860288 Ext: 379 (Sungai Long Campus)
Email Address	: financialaid@utar.edu.my